## Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:		NEW ASSIGNMENT			
NATURE OF CONVEYANCE:		ASSIGNMENT			
CONVEYING PART	Y DATA				
		Name	Execution Date		
Shin-Puu Jeng			01/11/2007		
Shih-Hsun Hsu		01/12/2007			
RECEIVING PARTY	Ó DATA				
Name:	Taiwan Semiconductor Manufacturing Company, Ltd.				
Street Address:	No. 8, Li-Hsin Rd. 6				
Internal Address:	Science-Based Industrial Park				
City:	Hsin-Chu				
State/Country:	TAIWAN				
Postal Code:	300-77				
PROPERTY NUMBERS Total: 1 Property Type		Number			
		4428			
CORRESPONDENCE DATA         Fax Number:       (972)732-9218         Correspondence will be sent via US Mail when the fax attempt is unsuccessful.         Phone:       972-732-1001         Email:       engeldahl@slater-matsil.com         Correspondent Name:       Slater & Matsil, L.L.P.         Address Line 1:       17950 Preston Road, Suite 1000         Address Line 4:       Dallas, TEXAS 75252					
ATTORNEY DOCKET NUMBER:		TSM06-0167			
NAME OF SUBMITTER:		Kristy J. Engeldahl	Kristy J. Engeldahl		
Total Attachments: 1 source=TSM06-0167		.tif			

ATTORNEY DOCKET NO. TSM06-0167

## ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States. Letters Patent is made, the said application having been executed on the date set forth below; and

WHEREAS, Talwan Semiconductor Manufacturing Company, Ltd. (TSMC), a corporation organized and existing under the laws of Talwan, the Republic of China, with its principal office at No. 8, Li-Hein Rd. 6, Science-Based Industrial Park, Hein-Chu, Talwan 300-77, R.O.C., is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon in the United States and all other countries throughout the world;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby self and assign to the said TSMC, its successors and assigns, my entire right, title and interest in and to the said invention and in to the said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner for Patents to issue all patents for said invention, or patent resulting thereform, insofar as my interest is concerned, to the said TSMC, as assigned of my entire right, title and interest. I declare that I have not executed and will not execute any agreement in conflict herewith.

I also hereby sell and assign to TSMC, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including, but not limited to, the right to Re applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therawith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said TSMC, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention or the file history thereof, and at the expense of said assignee company, testify in any legal proceedings, sign all tawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said TSMC, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

TITLE OF INVENTION	Die Saw Crack Stopper				
SIGNATURE OF INVENTOR AND NAME		Shik-Hsun Hsu Shih-Hsun Hsu			
DATE	i/illoog	1/12/2007			
RESIDENCE (City, County, State)	Hsinchu Taiwan, R.O.C.	Keelung City 206 Taiwan, R.O.C.			
www.y					

IN WITNESS WHEREOF, I hereunto set my hand and seal this day and year;

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Assignment

## RECORDED: 02/15/2007

## PATENT REEL: 018894 FRAME: 0233